70434-0024

(Only for new nonprovisional applications under 37 CFR 1.53(b))

Total Pages in this Submission

Docket No.

TO THE ASSISTANT COMMISSIONER FOR PATENTS

Box Patent Application Washington, D.C. 20231

≡°	Washington, D.C. 20231									
Transmitted he invention entitle	erewith for filing under 35 U.S.C. 111(a) and 37 C.F.R. 1.53(b) is a new utility patent application for an									
Semiconductor Diode and Method for Manufacturing the Same										
and invented h	25.5.7.7.7.7.7.7.7.7.7.7.7.7.7.7.7.7.7.7									
and invented by: LEE, Ming Kwei										
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If 真 CONTINUATION APPLICATION, check appropriate box and supply the requisite information:										
Continu	ation Divisional Continuation-in-part (CIP) of prior application No.:									
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laj										
Eក្លីclosed are: Application Elements										
1. 🗵 Fi	1. Filing fee as calculated and transmitted as described below									
2. 🗷 S _l	pecification having pages and including the following:									
a. ⊠	Descriptive Title of the Invention									
b. ☐ Cross References to Related Applications (if applicable)										
c. 🗆	Statement Regarding Federally-sponsored Research/Development (if applicable)									
d. Reference to Microfiche Appendix (if applicable)										
e. 🗵 Background of the Invention										
f. 🗵 Brief Summary of the Invention										
• g. ⊠	Brief Description of the Drawings (if drawings filed)									
h. ⊠	Detailed Description									
i. 🛭	Claim(s) as Classified Below									
j. ⊠	Abstract of the Disclosure									

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Application Elements (Continued)

3.	X	Drawing(s) (when necessary as prescribed by 35 USC 113)							
	a.	➤ Formal b. ☐ Informal Number of Sheets4							
4.	X	Oath or Declaration							
	a.	a. 🗵 Newly executed (original or copy)							
	b.	b. Copy from a prior application (37 CFR 1.63(d)) (for continuation/divisional application only)							
	C.	With Power of Attorney □ Without Power of Attorney							
	d.	DELETION OF INVENTOR(S) Signed statement attached deleting inventor(s) named in the prior application, see 37 C.F.R. 1.63(d)(2) and 1.33(b).							
		Incorporation By Reference (usable if Box 4b is checked) The entire disclosure of the prior application, from which a copy of the oath or declaration is supplied under Box 4b, is considered as being part of the disclosure of the accompanying application and is hereby incorporated by reference therein.							
6.		Computer Program in Microfiche							
. 7.		Genetic Sequence Submission (if applicable, all must be included)							
[]	a.	☐ Paper Copy							
	b.	☐ Computer Readable Copy							
	C.	Statement Verifying Identical Paper and Computer Readable Copy							
		Accompanying Application Parts							
8.	X	Assignment Papers (cover sheet & documents)							
9.		37 CFR 3.73(b) Statement (when there is an assignee)							
10.		English Translation Document (if applicable)							
11.		Information Disclosure Statement/PTO-1449 Copies of IDS Citations							
12.		Preliminary Amendment							
13.	×	Acknowledgment postcard							
14.		Certificate of Mailing							
		☐ First Class ☐ Express Mail (Specify Label No.):							

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was unintentional.

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		Accompanying Application Parts (Continued)						
15.		Certified Copy of Priority Document(s) (if foreign priority is claimed)						
16.	Small Entity Statement(s) - Specify Number of Statements Submitted: 2							
17.		Additional Enclosures (please identify below):						
The second secon		Request That Application Not Be Published Pursuant To 35 U.S.C. 122(b)(2) Pursuant to 35 U.S.C. 122(b)(2), Applicant hereby requests that this patent application not be published pursuant to 35 U.S.C. 122(b)(1). Applicant hereby certifies that the invention disclosed in this application has not and will not be the subject of an application filed in another country, or under a multilateral international agreement, that requires publication of applications 18 months after filing of the application.						
lai lai		Warning						
		An applicant who makes a request not to publish, but who subsequently files in a foreign country or under a multilateral international agreement specified in 35 U.S.C. 122(b)(2)(B)(i), must notify the Director of such filing not later than 45 days after the date of the filing of such foreign or international application. A failure of the applicant to provide such notice within the prescribed period shall result in the application being regarded as abandoned, unless it is shown to the satisfaction of the Director that the delay in submitting the notice						

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			Fee Calculati	ion and Trar	nsmittal		_			
			CLAIMS A	S FILED						
	For	#Filed	#Allowed #	#Extra	R	ate	Fee			
Tota	l Claims	14	- 20 =	0	× \$	59.00	\$0.00			
. 227.11	p. Claims	2	- 3 =	0	× \$4	42.00	\$0.00			
	iple Dependent Cl	aims (check if a	applicable) 🗆]			\$0.00			
, m						BASIC FEE	\$370.00			
:523	HER FEE (specify	purpose)		Assignm	ient		40.00			
						TOTAL FILING FEE	\$410.00			
A check in the amount of \$410.00 to cover the filing fee is enclosed. The Commissioner is hereby authorized to charge and credit Deposit Account No. 04-1061 as described below. A duplicate copy of this sheet is enclosed. Charge the amount of as filing fee. Credit any overpayment.										
 Charge any additional filing fees required under 37 C.F.R. 1.16 and 1.17. Charge the issue fee set in 37 C.F.R. 1.18 at the mailing of the Notice of Allowance, pursuant to 37 C.F.R. 1.311(b). 										
Date	d: 23 JAN 2002				9	Signature				
cc:										